

45V, 6mΩ, 80A, Single N-Channel

1.Features

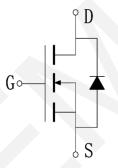
- 45V MOSFET technology
- Low on-state resistance
- Fast switching
- Vgs±20V

2.Applications

- Power Switching Application
- Load Switching



Pin Description



Schematic Diagram

3.Absolute Max Ratings at Ta=25°C (Note1) **Parameter** Symbol Maximum Units Drain to Source Voltage V VDSS 45 V Gate to Source Voltage V_{GSS} ±20 80 Drain Current (DC) I_D А Drain Current (Pulse), PW≤300µs 216 А **I**DP W Total Dissipation P_{D} 80 Avalanche Energy, Single Pulsed E_{AS} 113 mJ **Junction Temperature** Tj 150 °C T_{stg} Storage Temperature -55 to +150 °C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4. Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	R _{θJC}	1.8	°C/W

Note 2: When mounted on 1 inch square copper board $t \le 10$ sec The value in any given application depends on the user's specific board design.



5. Electrical Characteristics at Ta=25°C (Note 3)								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units		
Drain to Source Breakdown Voltage	V _{(BR)DSS}	$I_{D} = 250 \mu A, V_{GS} = 0 V$	45	52		V		
Zero-Gate Voltage Drain Current	I _{DSS}	V_{DS} = 20V, V_{GS} = 0V			1	μA		
Gate to Source Leakage Current	I _{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _{DS} =250µA	1	1.6	2.5	V		
Static Drain to Source On-State Resistance	R _{DS(on)}	I _D = 20A, V _{GS} = 10V	-	6		mΩ		
		I _D = 20A, V _{GS} = 4.5V	-	10.6		mΩ		
Forward Transconductance	G _{FS}	I _D = 20A, V _{DS} = 10V	15			S		
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =20V, Frequency=1.0MHz		2662		рF		
Output Capacitance	Coss			322		pF		
Reverse Transfer Capacitance	Crss			246		pF		
Turn-ON Delay Time	t _{d(on)}			12		ns		
Rise Time	tr	$V_{DD} = 20V, R_L = 1\Omega$ $V_{GS} = 10V, R_G = 3\Omega$		11		ns		
Turn-OFF Delay Time	t _{d(off)}			39		ns		
Fall Time	t _f			12		ns		
Total Gate Charge	Qg	$V_{DS} = 20V,$ $V_{GS} = 10V,$ $I_D = 20A$		54.3		nC		
	Q _{gs}			6.9		nC		
	Q _{gd}			14.5		nC		
Diode Forward Voltage	V _{FSD}	I _S = 10A, V _{GS} = 0		0.9	1.2	V		

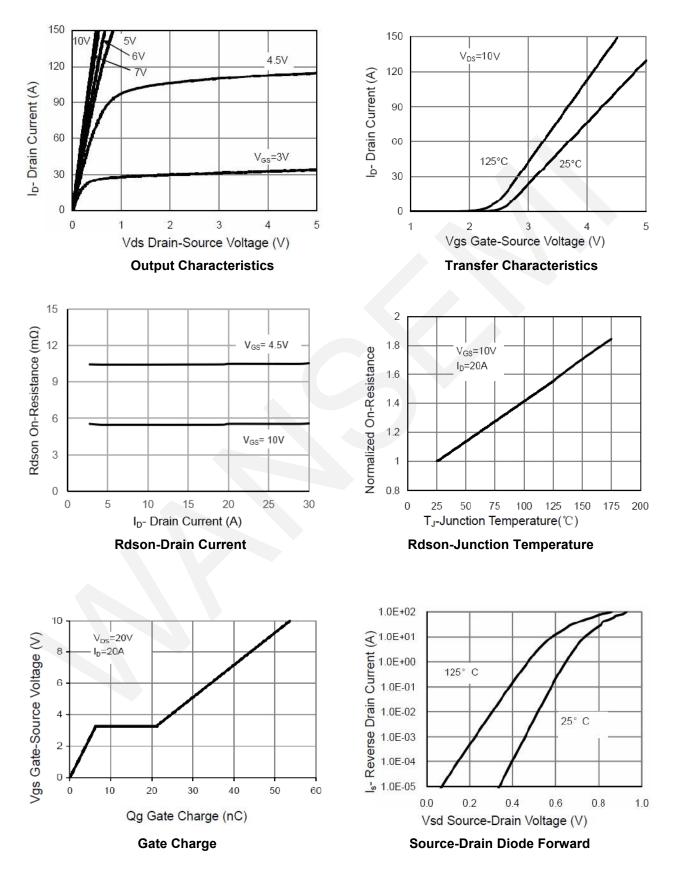
5.Electrical Characteristics at Ta=25°C (Note 3)

Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



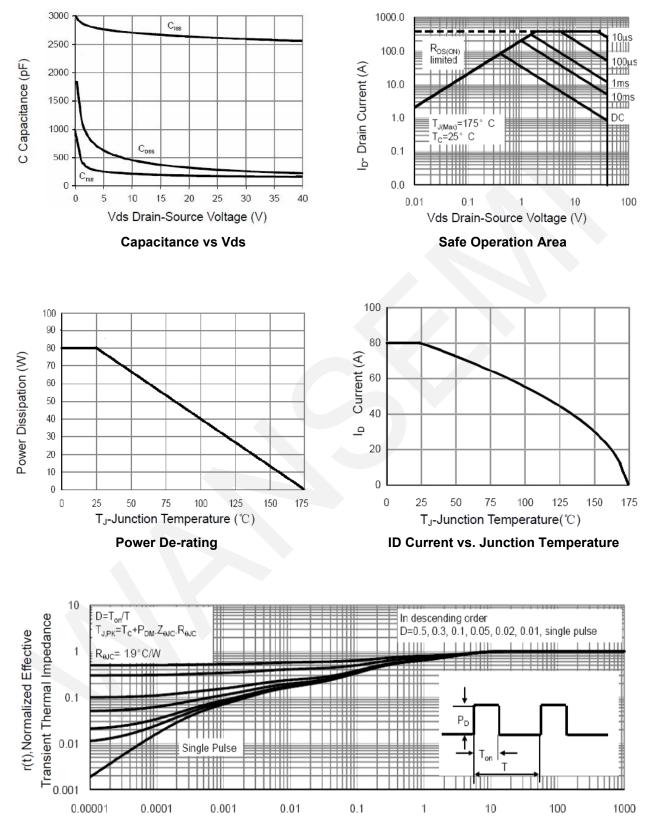


6.Typical electrical and thermal characteristics



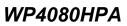


WP4080HPA



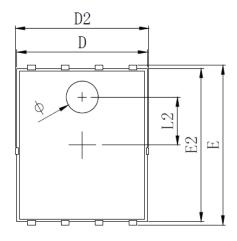
Square Wave Pluse Duration(sec)

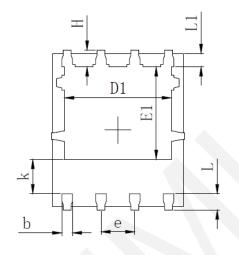
Normalized Maximum Transient Thermal Impedance

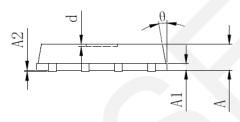




7.Package Dimensions







			_		
SYMBOL	MILLIMETER				
0 TADOL	MIN	Тур.	MAX		
А	0.900	1.000	1.100		
A1	0.254 REF.				
A2	0~0.05				
D	4.824	4.900	4.976		
D1	3. 910	4.010	4.110		
D2	4. 924	5.000	5.076		
E	5. 9 24	6.000	6.076		
E 1	3.375	3. 475	3. 575		
E2	5.674	5.750	5.826		
b	0.350	0.400	0.450		
е	1.270 TYP.				
L	0.534	0.610	0.686		
L1	0.424	0.500	0.576		
L2	1.800 REF.				
k	1.190	1.290	1.390		
Н	0.549	0.625	0.701		
θ	8°	10°	12°		
φ	1.100	1.200	1.300		
d			0.100		



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